Embeddable RFID

Low, high and ultrahigh-frequency transponders for enclosure into virtually any form factor



Embeddable RFID transponders allow manufacturers to integrate HID Global electronic components seamlessly into tag designs optimized for any application.

Leveraging HID experience, manufacturers and integrators can combine their specialized market expertise to deliver optimized tagging solutions for custom automation applications. Manufacturers can save the time and expense of electronics design and production, and better focus resources on providing customer solutions.

With a variety of integrated chips, HID offers a range of Embeddable RFID components various operating frequencies, and form factors for incorporation into finished tagging solutions.

Choose from:

- E-Unit Disc transponders low frequency HID coils and chips, ideal for keyfobs and similar simple applications.
- Inlays & Labels NFC or UHF inlays or printable labels are easy to apply via glue to smart posters etc.

- Logi Tag[™] 180 UHF near-field transponders, small and robust.
- MuTRAKTM UHF ultra-small and robust transponders, ideal to identify small items.
- Clear Disc transponders low and high frequency electronics sealed in a transparent plastic coating that provides resistance to chemical exposure, shock, vibration and thermal fluctuations, both during and after production.
- Piccolino Tag transponders for space-constrained applications, our smallest disc-shaped units deliver high frequency performance and up to a 16 kbit read-write memory.
- E-Unit Rod transponders provide the same high-performance coil design at the heart of the HID Glass Tag family, for embedding into your preferred housing. Rod-shaped units may be preferred when a more precisely directed radio frequency field is needed or a linear form factor is required.
- Sentry PCB tags highly durable, small transponders suitable for embedding, see separate Sentry PCB datasheet for details.

If a standard configuration does not fulfill your needs, HID engineers can customize a transponder unit to meet your requirements.



KEY BENEFITS

- **Customizable** choose a size, chip and a disc or rod to fit any custom enclosure
- Unsurpassed quality fully automated manufacturing and innovative DBond[™] technology ensure tag reliability
- Reliable operation built to withstand the rigors of tag processing, including plastic injection molding

TECHNOLOGY HIGHLIGHTS:

- A selection of housing materials to meet a variety of production process demands
- A multitude of available integrated chip options
- Embeddable in a broad spectrum of materials
- LF, HF and RAIN UHF Options

For more information, contact tagsales@hidglobal.com



| | Embeddable RFID | | | | | | | | | | |
|---------------------------|---|----------------------|----------------------|----------------------|-------------------------|----------------------|--|--|--|--|--|
| | Clear Disc | | | | | | | | | | |
| | Hitag S | | Q5 | U | MIFARE DESFire EV1 4 | | | | | | |
| | 20 mm | 22 mm | 30 mm | 20 mm | 30 mm | 25 mm | | | | | |
| | 0 | 0 | O | 0 | \bigcirc | | | | | | |
| Base Model Number | 624116 | 612116 | 612117 | 601116 | 601117 | 7A1119 | | | | | |
| | ELECTRONIC | | | | | | | | | | |
| Operating Frequency | 125 kHz 13.56 MHz | | | | | | | | | | |
| Chip Type | HITAG S | Q5 | | Unique | MIFARE DESFire EV1 | | | | | | |
| Memory | 2048 bit EEPROM | 256 bit EEPROM | | | 4 KB EEPROM | | | | | | |
| Anti-collision | Yes | Yes | | | | | | | | | |
| Reading Distance | Dependent upon reader, environment and application | | | | | | | | | | |
| | PHYSICAL | | | | | | | | | | |
| Outer Coil Diameter | Ø 0.79 in (20 mm) | Ø 0.87 in (22 mm) | Ø 1.18 in (30 mm) | Ø 0.79 in (20 mm) | Ø 1.18 in (30 mm) | Ø 0.98 in (25 mm) | | | | | |
| Inner Coil Diameter | 0.02 in (0.6 mm) | | | | | | | | | | |
| Thickness | 0.02 in (0.6 mm) 0.03 in (0.75mm) | | | | | | | | | | |
| Mounting Method | Embed, glue | | | | | | | | | | |
| Housing Material | Polyethylen + Polyester (outside) | | | | | | | | | | |
| | CHEMICAL AND MECHANICAL | | | | | | | | | | |
| Water | Depends on finished proc | duct | | | | | | | | | |
| Withstands Exposure To | Depends on finished product | | | | | | | | | | |
| Vibration | Depends on finished product | | | | | | | | | | |
| Shock | Depends on finished product | | | | | | | | | | |
| | THERMAL | | | | | | | | | | |
| Storage | -4° to +140° F (-20° to +60° C) | | | | | | | | | | |
| Operating | -4° to +140° F (-20° to +60° C) | | | | | | | | | | |
| | OTHER | | | | | | | | | | |
| Standards | | | | | | | | | | | |
| Box Size | 5000 pcs | 5000 pcs | 2000 pcs | 5000 pcs | 2000 pcs | 500 pcs | | | | | |
| Options | Alternative sizes and chips (e.g. HDX). See separate datasheet for inlays & labels. | | | | | | | | | | |
| | 2 Years | | | | | | | | | | |

APPLICATION AREAS:

- Asset tracking and logistics
- Gas bottles
- Utility lines

AUTOMATION AND MANUFACTURING

- Tool maintenance
- Process accountability

MEDICAL AND HEALTH

- Consumables
- Instruments

| | Embeddable RFID | | | | | | | | | | | |
|---------------------------|---|---|--------------------------|--------------------------|---|---|---|--------------------------------|-------------------------------------|-------------------------------------|--|---|
| | E-Unit Disc | | | | E-Unit Rod | Piccolino Tag | | | | | Logi Tag | MuTRAK |
| | EM4305 / HITAG S | | HITAG S | ICODE SLIX2 ICODE DNA | | Vigo™ | F-Mem | Monza R6-P | M730 | | | |
| | 24 r | nm | 28 | 3 mm | 15 mm | 7.5 mm | 9.5 r | nm | 6/9.5 mm | 6/9.5 mm | 18 mm | 7 mm |
| | 0 | 0 | 0 | 0 | 1 | | | | | | | 9 |
| Base Model Number | 684620 (EM4305) 623620 (HITAG S) | 684680 (EM4305) 623610 (HITAG S) | 623620 | 623610 | 201045 | 629191-012 | 629190-012 629190-312 (OM) | 6K3190 | 6B0192 (6 mm) 6A9190 (9mm) | 6C9192 (6 mm) 634190 (9mm) | 6H2112 | TM730E01 |
| | ELECTRON | IC | | | | | | | | , | | |
| Operating Frequency | 134.2 kHz | | | | | 13.56 MHz | | | | | 860-960 MHz (Worldwide) | |
| Chip Type | EM4305/HITAG | S | | | HITAG S | ICODE SLIX2 ICODE DNA Vigo | | F-Mem | Monza R6-P | M730 | | |
| Memory | 512 bit EEPROM (EM4305) 256 bit EEPROM(HITAG S) 256 bit EEPROM | | 256 bit EEPROM | | | 1664 bit (6 mm) 1024 bit (9 mm) EEPROM | 2 kbit (6 mm) 16 kbit (9 mm) FRAM | 28/96 bit EPC, 32/64 bit UM | 128 bits EPC | | | |
| Anti-collision | Yes | | | | | | | | | | | |
| Reading Distance | Dependent upon reader, environment and application | | | | | | | | | | | |
| | PHYSICAL Ø0.97 in | Ø 1.09 in | Ø 0.97 in | Ø1.09 in | 1 | Ø 0.30 in | Ø 0.37 in | | Ø 0.23/0.37 in | | Ø 0.6 in | 0.27 x 0.27 in |
| Outer Coil Diameter | (Ø 24.3 mm) Ø 0.79 in | (Ø27.8mm) Ø0.93 in | (Ø 24.3 mm) Ø 0.79 in | (Ø 27.8mm) Ø 0.93 in | | (Ø 7.5 mm) | (Ø 9.5 mm) | | (Ø 6/9.5 mm) | | (18 mm) | (7 x 7 mm) |
| Inner Coil Diameter | (Ø 20 mm) | (Ø23.5mm) | (Ø 20 mm) | (Ø23.5mm) | | | | | | | I | T |
| Thickness | 0.03 in (0.85 mm) | 0.09 in (2.2 mm) | 0.03 in (0.85 mm) | 0.09 in (2.2 mm) | Ø 0.07 x 0.59 in (Ø1.8x 15mm) | 0.04 in (1 mm) / | 0.03 in (0.8 mm) f | 0.1 in (3 mm) | 0.05 in (1.4 mm) | | | |
| Mounting Method | Embed, glue | | | | | | | | | | | Sew into hem or pouch or heat seal under a patch for textile applications. Embed, glue for other applications. |
| Housing Material | Depends on finished product | | | | | Epoxy | | Polycarbonate | Epoxy | | | |
| | CHEMICAL AND MECHANICAL | | | | | | | | | | | |
| Water | Depends on finis | shed product | | | | IP67, 68° F (20 | ° C), 3.3 ft (1 m | IP68, 6.6 ft (2 m) x 24 h | | | | |
| Withstands Exposure To | Impact IEC 62262 100 drops 5.9 ft (1. | | | | | | | | | | Impact IEC 62262-IK07, 100 drops 5.9 ft (1.8 m), Axial/radial force 1000N | |
| Vibration | Depends on finished product | | | | | IEC 68.2.6 [10 g, 10 to 2000 Hz, 3 axis, 2.5 h] | | | | | | |
| Shock | Depends on finis | shed product | | | IEC 68.2.29 [40 g, 18 ms, 6 axis, 2000 times] | | | | | | | |
| | THERMAL | | | | | 1 | | 1 | | | | |
| Storage | -40° to +140° F (-40° to +60° C) | | | | | -40° to +185° F (-40° to 85° C), 1000 h | | | | | | |
| Operating | -13° to +140° F (-25° to +60° C) | | | | | -40° to +185° F (-40° to 85° C) -4° to +185° F (-20° to 85° C) | | | | | -40 °to +185° F (-40° to 85° C) Peak: Up to 284° F (140° C), 100 h | -40 °to +185° F (-40° to 85° C) Peak: Up to 392° F (200° C), 15 sec" |
| | OTHER | | | | | | | | | | | |
| Standards | ISO 11784, ISO 11785 | | | | | | | | | | | 2, ISO 18000-63 |
| Box Size | 1250 pcs | 1000 pcs | 1250 pcs | 1000 pcs | 39 912 pcs | 2000 pcs | | | | | | |
| Options | Alternative sizes and chips (e.g. HDX). See separate datasheet for inlays & labels. | | | | | | | | | | Chip reference and date code laser-engraved on transponder housing | |
| | 2 Years | | | | | | | | | | | |



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